

<u>AP80N07D</u>

68V N-Channel Enhancement Mode MOSFET

Description

The AP80N07D uses advanced trench technology

to provide excellent $R_{\text{DS}(\text{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 68V I_D =80A

 $R_{DS(ON)} < 8.6m\Omega @ V_{GS}=10V (Type: 6.5m\Omega)$

Application

Battery protection

Load switch

Uninterruptible power supply

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Package Marking and Ordering Information

Product ID	5	Pack	Marking	Qty(PCS)
AP80N07D	Ň	TO-252-3L	AP80N07D XXX YYYY	2500

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Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	68	V
VGS	Gate-Source Voltage	±20	V
I₀@Tc=25℃	Continuous Drain Current, V _{GS} @ 10V ¹	80	А
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	52	А
IDM	Pulsed Drain Current ²	320	А
EAS	Single Pulse Avalanche Energy ³	121	mJ
IAS	Avalanche Current	22	А
P₀@Tc=25℃	Total Power Dissipation ⁴	116	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
ReJA	Thermal Resistance Junction-ambient ¹	63	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	0.85	°C/W

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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	68	72		V
∆BVDSS/∆TJ	BVDSS Temperature Coefficient	Reference to 25℃ , I _D =1mA		0.023		V/℃
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =10A		6.5	8.6	mΩ
VGS(th)	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	2.0	3.0	4.0	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient			-4.2		mV/℃
IDSS	Drain-Source Leakage Current	$V_{\text{DS}}\text{=}24V$, $V_{\text{GS}}\text{=}0V$, $T_{\text{J}}\text{=}25^\circ\!\!\mathbb{C}$			1	uA
1000	Drain-Oource Leakage Ourrent	$V_{\text{DS}}\text{=}24V$, $V_{\text{GS}}\text{=}0V$, $T_{\text{J}}\text{=}55^\circ\!\!\mathbb{C}$			5	uA
IGSS	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =10A		5.5		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.3		Ω
Qg	Total Gate Charge (4.5V)			35		
Qgs	Gate-Source Charge	VDS =30V, ID =20A, VGS =10V		11		nC
Qgd	Gate-Drain Charge			9		
Td(on)	Turn-On Delay Time	V		15		
Tr	Rise Time	VDS =30V,I D =20A,		94		ns
Td(off)	Turn-Off Delay Time	RGEN =6Ω, V GS =10V		46		
T _f	Fall Time			32		
Ciss	Input Capacitance 🗙 🔪	~		4062		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		261		pF
Crss	Reverse Transfer Capacitance			231		
IS	Continuous Source Current ^{1,5}				80	Α
ISM	Pulsed Source Current ^{2,5}	$V_G=V_D=0V$, Force Current			320	Α
VSD	Diode Forward Voltage ²	V GS =0V, I S =80A			1.2	V
trr	Reverse Recovery Time	T J =25℃		78		nS
Qrr	Reverse Recovery Charge	I F =20A,dI/dt=100A/µs		51		nC

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Note :

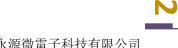
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width .The EAS data shows Max. rating .

3. The test cond \leq 300us duty cycle \leq 2%, duty cycle ition is TJ =25°C, VDD =35V, V G =10V, R G =25 Ω , L=0.5mH, IAS =22A

4. The power dissipation is limited by 175 $^\circ\!\mathrm{C}$ junction temperature

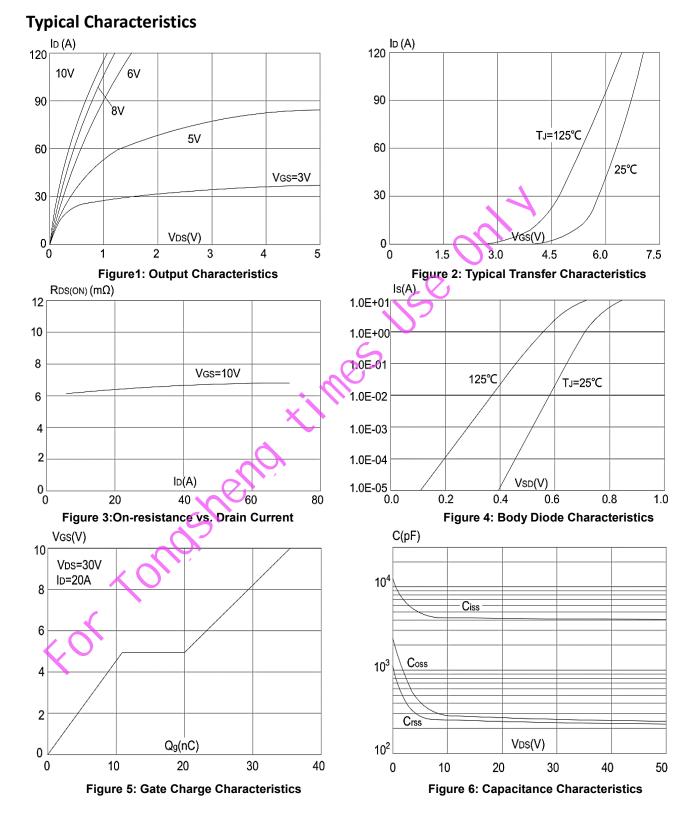
5. The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.





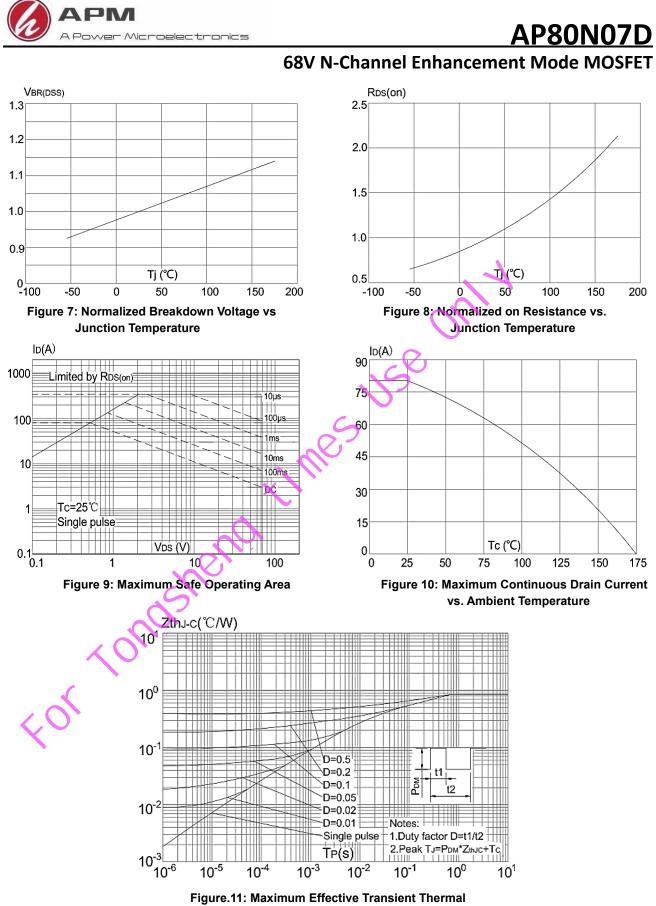
<u>AP80N07D</u>

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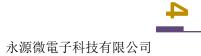


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Impedance, Junction-to-Ambien



APM
A Power Microelectronics

Inches

Max.

0.098 0.004 0.034

0.216 0.024 0.023 0.248

0.268

0.184

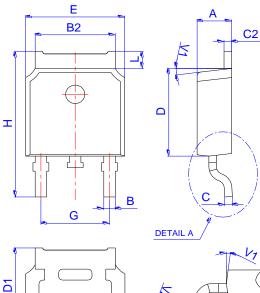
0.048 0.065

6°

68V N-Channel Enhancement Mode MOSFET

Dimensions

Package Mechanical Data: TO-252-3L



A2

DETAIL

L2

TO-252

		Min.	Тур.	Max.	Min.	Тур.	
	Α	2.10		2.50	0.083		
	A2	0		0.10	0		
	В	0.66		0.86	0.026		
	B2	5.18		5.48	0.202		
N.	С	0.40		0.60	0.016		
	C2	0.44		0.58	0.017		
	D	5.90		6.30	0.232		
1	D1		5.30REF		C	.209REF	
	E	6.40		6.80	0.252		
	E1	4.63	2,		0.182		
1	G	4.47		4.67	0.176		
7	Н	9.50		10.70	0.374		
		1.09		1.21	0.043		
	N N	1.35		1.65	0.053		
2	V1		7°			7°	
$\sim N$	V2	0°		6°	0°		

Millimeters

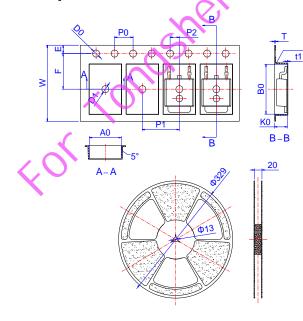
Ref.

5°MAX

Reel Spectification-TO-252

E1

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	Dimensions					
Ref.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

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Edition	Date	Change
RVE1.0	2020/12/21	Initial release

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